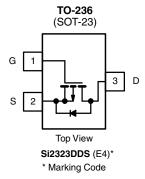




P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$ Max.	I _D (A) ^d	Q _g (Typ.)		
	0.039 at V _{GS} = - 4.5 V	- 5.3			
- 20	0.050 at V _{GS} = - 2.5 V	- 4.7	13.6 nC		
	0.075 at V _{GS} = - 1.8 V	- 3.8			



Ordering Information:

Si2323DDS-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

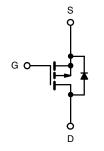
- TrenchFET® Power MOSFET
- 100 % R_a Tested
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



COMPLIANT HALOGEN FREE

APPLICATIONS

- Load Switch
- PA Switch
- DC/DC Converters
- **Power Management**



P-Channel MOSFET

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	- 20			
Gate-Source Voltage		V_{GS}	± 8	V	
	T _C = 25 °C		- 5.3	A	
Continuous Drain Current /T 150 °C)	T _C = 70 °C	,	- 4.3		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	- 4.1 ^{a,b}		
	T _A = 70 °C		- 3.2 ^{a,b}		
Pulsed Drain Current (t = 300 μs)	I _{DM}	- 20			
0 11 0 0 1	T _C = 25 °C	1	- 1.4		
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 0.8 ^{a,b}		
	T _C = 25 °C		1.7	· w	
Maximum Power Dissipation	T _C = 70 °C	Б	1.1		
	T _A = 25 °C	P_{D}	0.96 ^{a,b}		
	T _A = 70 °C		0.62 ^{a,b}		
Operating Junction and Storage Temperature R	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{a, c}	t ≤ 5 s	R_{thJA}	100	130	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	60	75	- °C/vv		

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 5 s.
- c. Maximum under steady state conditions is 175 $^{\circ}\text{C/W}.$
- d. $T_C = 25$ °C.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	, , , , , , , , , , , , , , , , , , ,				l		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 050 A		- 13		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		- 2.8			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.4		- 1	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Curvant	1	V _{DS} = - 20 V, V _{GS} = 0 V			- 1	μΑ	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = - 20 V, V _{GS} = 0 V, T _J = 55 °C			- 10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 15			Α	
		V _{GS} = - 4.5 V, I _D = - 4.1 A		0.032	0.039	0 Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 2 A		0.041	0.050		
		V _{GS} = - 1.8 V, I _D = - 1 A		0.058	0.075		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 4.1 A		18		S	
Dynamic ^b	L			I.	I	L	
Input Capacitance	C _{iss}			1160		pF	
Output Capacitance	C _{oss}	V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz		135			
Reverse Transfer Capacitance	C _{rss}			120			
Total Gate Charge	Qg	V _{DS} = - 10 V, V _{GS} = - 8 V, I _D = - 4.1 A		24	36		
Total Gate Charge	Qg			13.6	21	nC	
Gate-Source Charge	Q _{gs}	V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 4.1 A		2			
Gate-Drain Charge	Q _{gd}			2.2			
Gate Resistance	R_{g}	f = 1 MHz	2	10	20	Ω	
Turn-On Delay Time	t _{d(on)}			24	36		
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_L = 3.1 \Omega$		22	40		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 3.2 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		52	78		
Fall Time	t _f			11	20		
Turn-On Delay Time	t _{d(on)}			8	16	ns -	
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_L = 3.1 \Omega$		9	18		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 3.2 A, V_{GEN} = - 8 V, R_g = 1 Ω		58	87		
Fall Time	t _f			9	18		
Drain-Source Body Diode Characterist	ics						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 1.4	Α	
Pulse Diode Forward Current	I _{SM}				- 20	^	
Body Diode Voltage	V_{SD}	I _S = - 3.2 A, V _{GS} = 0 V		- 0.79	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			14	25	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 3.2 A, dl/dt = 100 A/μs, T _J = 25 °C		6	12	nC	
Reverse Recovery Fall Time	t _a	1		8		ne	
Reverse Recovery Rise Time	t _b	7		6		ns	

Notes:

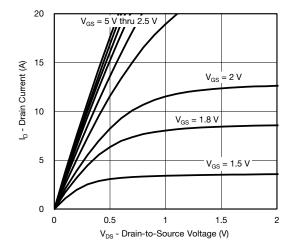
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

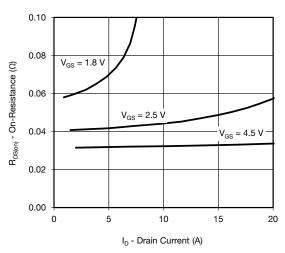
b. Guaranteed by design, not subject to production testing.



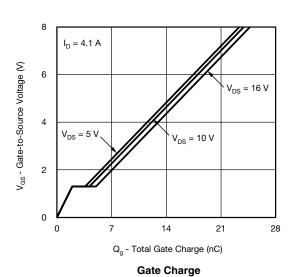
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

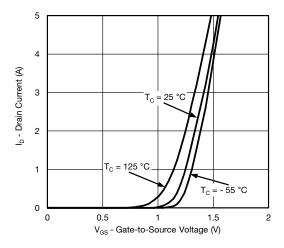


Output Characteristics

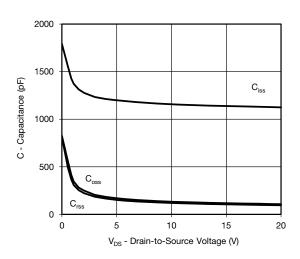


On-Resistance vs. Drain Current and Gate Voltage

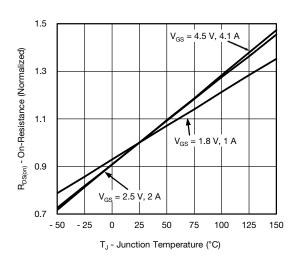




Transfer Characteristics

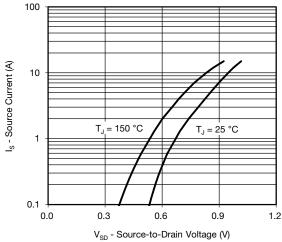


Capacitance

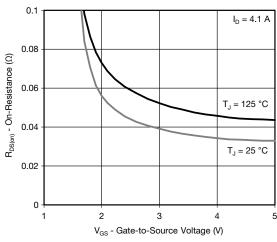


On-Resistance vs. Junction Temperature

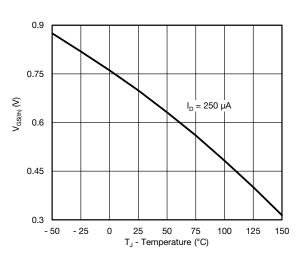
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



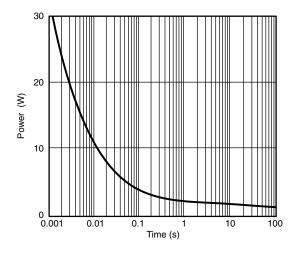
Source-Drain Diode Forward Voltage



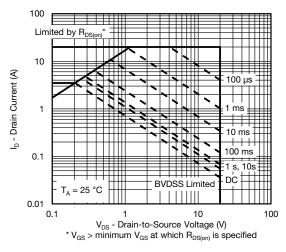
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



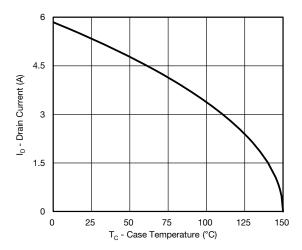
Single Pulse Power, Junction-to-Ambient

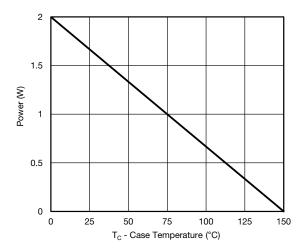


Safe Operating Area, Junction-to-Ambient



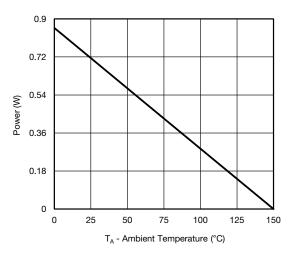
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





Current Derating*

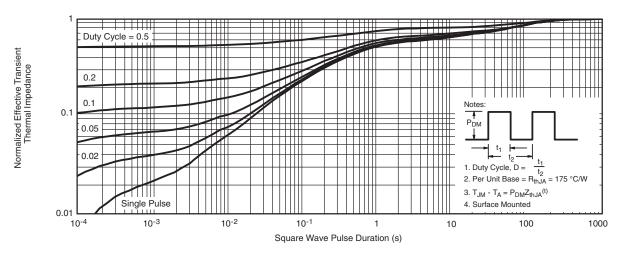
Power Derating, Junction-to-Foot



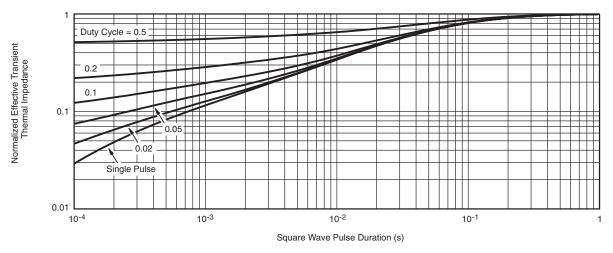
Power, Junction-to-Ambient

 $^{^{\}star}$ The power dissipation P_D is based on $T_{J(max.)}$ = 150 $^{\circ}$ C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOT-23 (TO-236): 3-LEAD







Dim	MILLIMETERS		INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.9	5 BSC	0.037	4 Ref	
e ₁	1.90 BSC		0.074	0.0748 Ref	
L	0.40	0.60	0.016	0.024	
L ₁	0.6	0.64 Ref 0.025 Ref		5 Ref	
S	0.5	0.50 Ref 0.020 Ref) Ref	
q	3°	8°	3°	8°	
FCN: S-03946-Rev K 09-	lul-01	•			

ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479

Document Number: 71196 www.vishay.com 09-Jul-01



RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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